

**IN THE ABSTRACT:**

Please replace the Abstract on page 9 of the translation with the attached unnumbered page containing an Abstract of the Disclosure. A marked-up version of the Abstract is attached herewith in the appendix.

**IN THE CLAIMS:**

Please amend claims 1-6 as follows:

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A3  
10 --1. (Amended) A substrate having at least two metallized polymer studs for soldered connections to a wiring and having conductor runs which lead away from the polymer studs on a lower face of the substrate, each of the polymer studs having at least one step in order to form at least one projection.--

--2. (Amended) The substrate according to claim 1, wherein the projection is a cylindrical projection which is arranged concentrically with respect to the polymer stud.--

15 --3. (Amended) The substrate according to claim 2, wherein the cylindrical projection has a diameter of between 100 $\mu$ m and 300 $\mu$ m, and a height of between 25 $\mu$ m and 250 $\mu$ m.--

--4. (Amended) The substrate according to claim 1, wherein the polymer studs are provided with two projections forming two steps.--

20 --5. (Amended) The substrate according to claim 1, wherein the polymer studs are provided with a number of projections arranged at a distance from one another on the step.--